



Rabbit 3000[®] Microprocessor

Data Sheet

030402

Rabbit 3000 Microprocessor Data Sheet

Printed in U.S.A.

©2002–2003 Rabbit Semiconductor • All rights reserved.

Rabbit Semiconductor reserves the right to make changes and improvements to its products without providing notice.

Trademarks

Rabbit and Rabbit 3000 are registered trademarks of Rabbit Semiconductor.

Dynamic C is a registered trademark of Z-World, Inc.

Rabbit Semiconductor

2932 Spafford Street
Davis, California 95616-6800
USA

Telephone: (530) 757-8400
Fax: (530) 757-8402

www.rabbitsemiconductor.com

Table of Contents

Hardware

Introduction	5
Block Diagram and Overview	6
I/O Electrical and 5-Volt Tolerant I/O	8
Oscillator, Spectrum Spreader, Clock Divider, Clock Doubler	8
Battery-Backable Clock, Watchdog Timer, Periodic Interrupt, 32 kHz Clock	8
Timers	9
Serial Ports	9
Memory Interface	10
Parallel I/O and Motion Control	10
Slave Port	11
I/O Bus and Auxiliary I/O Bus	11
Electrical and Mechanical Specifications	13
Electrical Specifications	13
LQFP Package	16
Ball Grid Array Package	19
Rabbit Pin Descriptions	22

Software

Rabbit 3000 Architecture and Software	25
Processor Architecture	25
Instruction Set	26
Development Environment/Dynamic C	26
Key Features	28
Standard Debugging Features	28
Network Connectivity and TCP/IP	29
C Libraries	31
Benchmarks	31

Background

Low-EMI Solutions	33
Using the Clock Spectrum Spreader	34
Low-Power Solutions	35
Sources of Power Consumption	35
Options for Lowering the Clock Speed	35
Sleepy Mode	36
Memory Chip Selection Options	37
Battery-Backed Time/Date and Battery-Backed Memory	38

Support

Sources of Support	41
Direct Support	41
Seminars/Trade Shows	41
Visits	41
Documentation/Designs	42
Parts Store	42
Development Kits	42
Core Modules	42

Rabbit 3000 Microprocessor User's Manual

Rabbit 3000 Microprocessor and Embedded Design System

The Rabbit 3000 is a modern 8-bit microprocessor that is the central element of a complete and fully supported embedded design system that includes development tools, software libraries, core modules, sample designs, a parts store, and readily available expert, human support.

The Rabbit 3000 shares its instruction set and conceptual design with the successful Rabbit 2000. The instruction set is based on the Z80/Z180, but has been adapted to be C-friendly and to allow a megabyte of code space. Rabbit processors are fast with compact code.

The Rabbit has an extensive array of on-chip peripherals including 6 serial ports, 56 parallel I/O pins, motion control interfaces, a time/date clock, glueless memory and I/O interfacing, a slave interface, and in-circuit programming. Low EMI features including a clock spectrum spreader eliminate schedule-wrecking EMI problems.

Software development support is based on Z-World's Dynamic C, and includes extensive libraries for Internet connectivity.

Together with our software, the Rabbit is a very strong performer as our benchmarks show. Rabbit-based core modules can be used to speed development.

Click the hypertext links for more information and consult the *Rabbit 3000 Microprocessor User's Manual* for a complete specification.



Block Diagram and Overview

- The Rabbit 3000 is packaged in either a 128-pin LQFP or a 128-pin TFBGA package.
- The operating voltage is nominally 3.3 V.
- Process is 0.35 μm CMOS.
- Maximum clock speed is 55 MHz (preliminary).
- Normal Operating voltage is 3.3 V plus or minus 10%.
- Normal Temperature Range is -55°C to $+85^{\circ}\text{C}$.

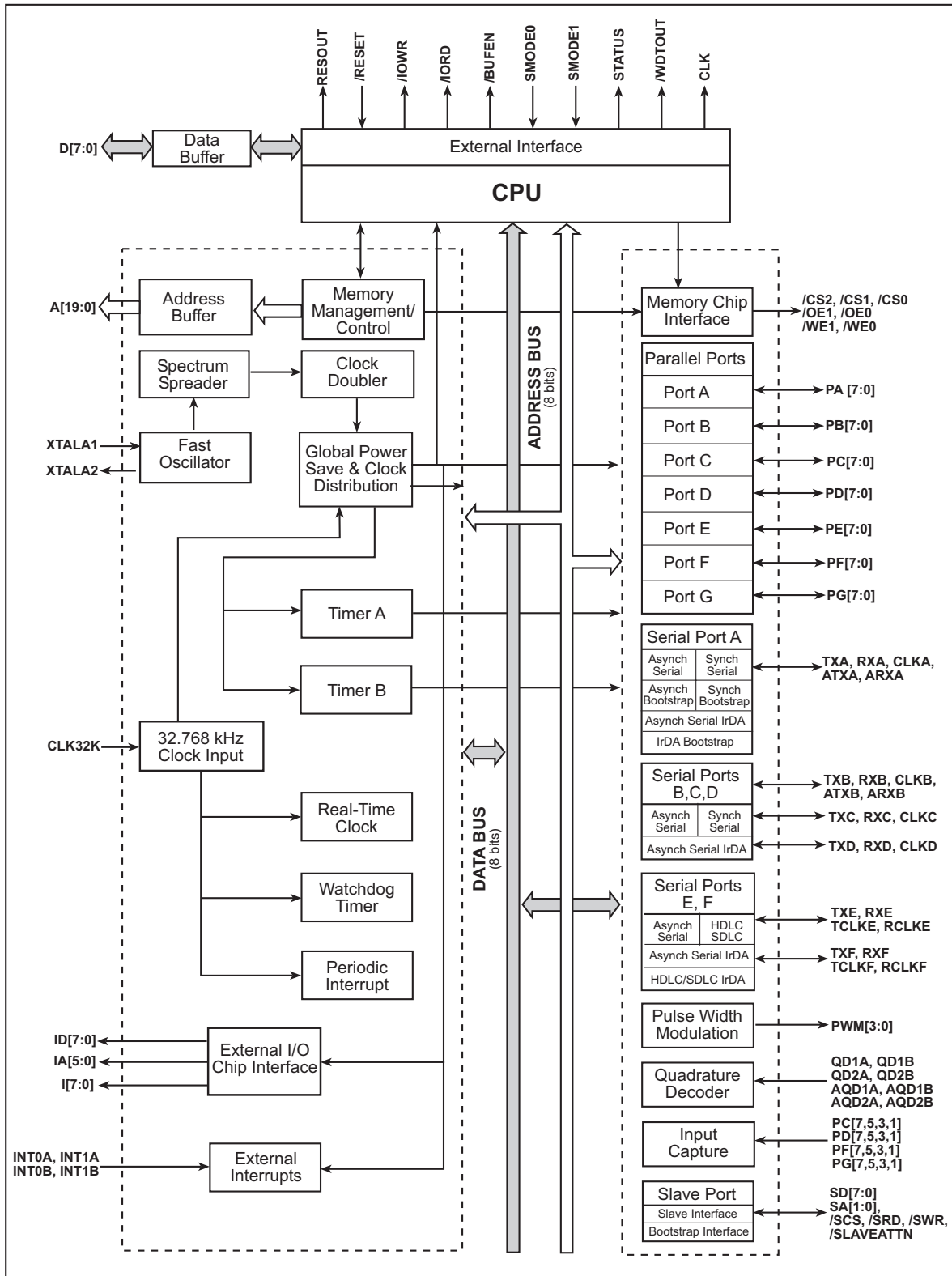


Figure 1. Rabbit 3000 Block Diagram

I/O Electrical and 5-Volt Tolerant I/O

While the normal operating voltage is 3.3 V plus or minus 10%, lower operating voltages down to 1.5 V are acceptable, leading to lower power consumption, but the maximum clock speed will be reduced. Higher operating temperatures to 105°C are acceptable provided the junction temperature is kept below 125°C, the Rabbit 300 will experience greater device life stress. The possibility of failure is significantly higher at temperatures over 125°C.

The preliminary maximum clock speed is 50 MHz for industrial conditions at 3.3 V plus or minus 10% over a temperature range from -55°C to +85°C. For commercial conditions, the preliminary maximum clock speed is 54 MHz at 3.3 V plus or minus 5% over a temperature range from -40°C to +70°C.

Signal inputs except oscillator buffers are +5 V tolerant, meaning that voltages up to 5.5 V may be applied with only leakage currents. This makes it easy to interface +5 V devices that have a 2 V or 2.4 V switching level. This includes HCT CMOS devices as well as most memory devices designed to operate at 5 V.

Signal outputs can generally drive 6 mA, sourcing or sinking, on a continuous DC basis.

The current consumption is 60 mA at 30 MHz and 3.3 V, and is approximately proportional to the operating frequency and operating voltage.

The die to ambient thermal impedance is 59°C/W at zero air flow (LQFP package). At 3.3 V, 50 MHz, and a current consumption of 100 mA, this would result in about 19°C of die self-heating. The clock speed is derated or uprated by approximately 1.2% for each 5°C of heating or cooling.

Oscillator, Spectrum Spreader, Clock Divider, Clock Doubler

An external oscillator can be used or a simple crystal circuit can be connected to the built-in oscillator buffer. Normally the external crystal or resonator has a frequency ½ the desired internal clock speed. The clock doubler circuit is used to double the input clock speed. The clock speed can be reduced dynamically by disabling the doubler or enabling the clock divider. This can be used to reduce power consumption. For extremely low power consumption, the CPU can be driven by the 32 kHz clock, which can be divided down as low as 2 kHz to further reduce power consumption (sleepy mode). When the 32 kHz clock is used, the main oscillator is normally turned off by the software. This saves about 2 mA of current.

The clock spectrum spreader modulates the clock frequency, spreading the energy of the higher harmonics over a broader spectrum, thus greatly reducing radiated EMI in any particular band and generally giving a 15–25 dB advantage on FCC and CE EMI tests.

Battery-Backable Clock, Watchdog Timer, Periodic Interrupt, 32 kHz Clock

Normally an external 32.768 kHz oscillator is provided to the Rabbit 3000 to drive a number of special functions. Rather than having a built-in oscillator buffer, a suggested low-cost external circuit based on a “tiny logic” buffer is recommended. A battery-backable 48 bit clock can be used to keep track of the time and date. This is driven at 32 kHz and consumes approximately 3 µA when the recommended circuit is used. A separate power pin is provided for the battery-backable

clock so that the clock may remain powered while the rest of the processor is powered down. A simple circuit requiring a single transistor can switch power from the power supply to the backup battery for the clock as well as for an external battery-backed RAM memory, if desired.

The watchdog timer forces a processor reset after a settable delay when enabled, and if not “hit” within the delay time which ranges from ¼ to 2 seconds. This protects the system against infinite loops and other types of software or hardware faults. The watchdog time is driven by the 32 kHz clock.

The periodic interrupt interrupts the processor 2048 times per second when enabled. This is driven from the 32 kHz oscillator. It may be used for any utility purpose and for accurate time keeping. Z-World software supports the use of this interrupt for a variety of purposes.

The 32 kHz clock is used to generate an initial 2400 bps baud clock. The 32 kHz oscillator is also used to drive the first stage of the cold boot via Serial Port A hardware so that the boot may be accomplished without initially knowing the frequency of the main oscillator crystal. Once the boot is under way, the main oscillator frequency can be determined by comparing it with the 32 kHz oscillator.

Timers

There are ten “A” timers. Each timer can divide by a factor from 1 to 256 using a reloadable countdown register. Timer A1 serves as a prescaler for the other timers. Timers A2–A7 are used to generate a baud clock for the 6 serial ports. Any of these can also cause interrupts and clock the timer-synchronized parallel output ports. Timers A8, A9, and A10 are respectively dedicated to drive the input capture, the pulse-width modulator, and the quadrature decoder hardware.

The one “B” timer is used to generate precisely timed output pulses by means of a 10-bit counter and two comparison registers. When the timer matches the contents of the comparison register, a timing event occurs that can be used to trigger a change of state in a parallel-port output.

Serial Ports

There are 6 serial ports named A–F. The ports do not all have the same capabilities. The capabilities are given in the following list.

- **Asynchronous**—Maximum baud rate 1/8th processor clock, 7 or 8 data bits, 9th address bit protocol, 1 or 2 stop bits, parity bit. IrDA support sending and receiving for direct connect to infrared transceiver. Adjustable interrupt priority. Supported by all 6 ports A–F.
- **Clocked Serial (SPI)**—Transmits and receives 8 data bits clocked by separate clock line. Clock may be provided internally or externally. Full duplex possible. Easy interface to many serial devices, shift registers or programmable logic. The maximum data rate is the processor clock divided by 2 if an internal clock is used or the processor clock divided by 6 if an external clock is used.
- **Cold Boot**—Serial Port A only may be used to cold-boot the processor remotely in conjunction with 2 mode pins that force the cold-boot mode when the processor exits the reset state. Initial communication is at 2400 bps controlled by the 32 kHz clock. Serial Port A is also used for software debugging, but may be used by user applications with some precautions. (It is also possible to cold-boot the processor using the SPI mode of Serial Port A, or by using the slave port in a parallel mode.)

- **HDLC/SDLC**—Only Serial Ports E and F have the capability to operate with this synchronous protocol. The clock can be separate, generated locally or remotely, or embedded in the data signal. If the clock is embedded in the data signal, then a built-in digital phase-lock loop extracts the clock. The following 5 types of signal modulation can be used: NRZ, NRZI, biphas-level (Manchester), biphas mark (FM0), or biphas space (FM1). Serial Ports E and F have a 4-byte receive fifo compared to the 1-byte buffers on the other serial ports. This aids in handling the higher speeds often used for synchronous communication. CRC checking, bit stuffing, and other essential functions are handled by the hardware. The maximum clock speed using an embedded clock and the digital phase lock loop is 1/16th the processor clock speed. If a separate external clock is used, the maximum data rate is 1/6th of the internal processor clock. *(Using a 12.352 MHz crystal doubled to 24.704 MHz, the T1 line speed of 1.544 MHz can be obtained using the phase-lock loop as well as standard baud rates with less than 1% error starting at 115,200 bps. A 16.384 MHz crystal will work for the 2.048 MHz E1 speed with small (1.23% max) standard baud errors.)*

Memory Interface

The Rabbit 3000 has an easy-to-use memory interface that can directly connect up to 6 static memory chips, either flash memory or static RAM. There are 3 chip selects, /CS0, /CS1, and /CS2 that can be connected directly to the memory chip select pin. There are 2 pairs of output enables and write enables, /OE0, /WE0 and /OE1, /WE1 that can be connected directly to the corresponding memory chip pins. There are 20 address lines and 8 bidirectional data lines.

The memory cycle is 2 clocks long for read and 3 clocks long for write. This results in exceptional stability for the memory bus timing, with no possibility of bus fights or critical setup or hold timings. Wait states may be added to the memory cycle in increments of 1, 2, or 4 clock periods. The address out time from the clock is very fast, in the range of 6–9 nanoseconds worst case, depending on address bus loading. This allows high clock speeds without exceptionally fast memory, for example, a 37 MHz clock speed with 45 ns flash memory with the spectrum spreader enabled. The spectrum spreader, in the common case, creates the need for 3 ns faster memory access time.

The Rabbit 3000 supports separate instruction and data space (I & D space). This makes it possible to enlarge data memory without resorting to long addresses and pointers.

Parallel I/O and Motion Control

The Rabbit 3000 has 7 parallel ports, each with 8 bits, for a total of 56 lines. Many of the ports share functionality with other devices so, depending on usage, some ports may be preempted by other functions such as serial I/O, the slave port, or the auxiliary I/O bus. Generally the output pins can drive 6 mA when the supply is 3.3 V. Certain ports are input or output only. Others can be configured on an individual pin basis as inputs or outputs. Some ports can be configured with as open drain outputs. A number of ports have synchronized outputs that can be timed using the facilities of Timer B so as to locate output transitions at precise times. Pulse-width modulation and pulse input capture units are available at a number of ports, as are optical-encoder inputs. Certain lines on Parallel Port E can be used as interrupt triggering inputs. The Parallel Port E lines can also be configured as I/O chip select, read strobes, write strobes, or read/write strobes.

Slave Port

The slave port is an unusual and powerful facility. The slave port is an 8-bit bidirectional port and associated control lines. It appears to the outside world (i.e., another processor) to be 4 registers. Similarly, the slave port also appears to be 4 registers to the Rabbit. The Rabbit and the outside processor can exchange data using these registers at high speed. Each side of the exchange provides its own clocking, so the exchange is asynchronous. Using the slave port, an entire Rabbit microprocessor system can be made to appear to be an I/O device controlled by the 4 registers. This allows the user to make a Rabbit system be a slave to another Rabbit or other microprocessor system. As an example, a system can be set up that appears to be a simple I/O device, but actually has the capability to translate simple commands into a complex protocol such as TCP/IP.

The slave port shares pins with Parallel Port A and certain pins on other ports. If the auxiliary I/O bus feature is used, it excludes the use of the slave port since they both rely on the same I/O pins.

I/O Bus and Auxiliary I/O Bus

I/O instructions on the Rabbit 3000 are the same as memory access instructions, except the instruction has a prefix byte that specifies that this is an I/O instruction. The I/O space is 64K in size, and is addressed by 16 address lines, compared to 1 megabyte and 20 address lines for the memory space. Separate synchronizing signals signal an I/O cycle: /IOW, /IOR. I/O cycles are 3 clocks long and can have 1, 6, or 14 additional wait states added. The I/O space is divided into 8 blocks of 8192 addresses. Wait states may be assigned separately for each block. In addition, pins on Parallel Port E can be programmed to provide I/O chip selects, read strobes, or write strobes that are enabled when an I/O cycle takes place in one of the 8192 address blocks. Internal devices use the first 256 I/O addresses, and the read or write cycles directed to internal devices are only 2 clocks in length.

A dilemma faced by many microprocessor system designers is resolving the conflict between a fast memory bus that should have low address and data line loading, and the need to share the same lines with an I/O bus that is extensive and may run between mother and daughter boards. The Rabbit 3000 has an optionally enabled auxiliary I/O bus that resolves this dilemma. This bus uses Parallel Port A for 8 bidirectional data lines and Parallel Port B for 6 I/O address lines. Other lines are the same as used for regular I/O transactions. If the auxiliary I/O bus is enabled then every I/O cycle executes on both the main memory bus and on the auxiliary bus. Memory cycles are ignored by the auxiliary bus. The 6 address lines remain in the last state until another I/O cycle executes and the auxiliary I/O bus data lines are in a high-impedance state between I/O cycles.

Having a separate I/O bus reduces EMI and ground bounce by limiting the fast memory bus to a few close in packages. Up to 64 registers may be addressed in any of the 8 blocks of memory for which I/O strobes are available. It is also possible to share the higher address lines with the memory bus. The higher lines have the advantage of not having as much switching activity as the low-order memory-bus-address lines.

Electrical and Mechanical Specifications

This section of the data sheet gives a concise and brief view of the electrical and mechanical specification. A more complete specification can be found in the *Rabbit 3000 Microprocessor User's Manual*.

Electrical Specifications

Table 1. Electrical Specifications 3.3 V Operation (preliminary)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
VDD	Operating Voltage		1.5	3.3	3.6	Volts
Temp	Temperature	Free Air	-55°C		85°C	deg C
MCLK	Max Clock Freq	-40°C to +70°C 3.3 V ±5%	0		54	MHz
MCLK	Max Clock Freq	-55°C to +85°C 3.3 V ±10%	0		50	MHz
Vin	Input Voltage	To meet switching speed standards	0.7 × VDD		5.5	volts
Isink	Sink Current	VDD 3.3V, Vout 1.0V	6			mA
Isrc	Source Current	VDD 3.3V, Vout 2.3V	6			mA
Ileak	Input Leakage	25C		0.01		uA
Ileak	Input Leakage	85C		0.5		uA
Tadr	Time to Address out from Clock	standard 30 pf load	2	3	5	ns
Tdin	Setup Time to Clock for Data				1	ns

Normal operating voltage for maximum clock frequency is 3.3 V, but operation down to 1.5 V is possible.

Derating of maximum clock speed for increased temperature or decreased voltage:

$$\text{Derating Factor} = [(VDD - 0.7)/3.0] \times (1 - (T - 85) \times 0.0025)$$

Example: Operating voltage is 1.5 V and temperature is 70°C. The derating factor is given by:

$$[(1.5 - 0.7)/3] \times (1 - (70 - 85) \times 0.0025) = 0.277$$

Thus the maximum operating frequency is given by $54 \times 0.277 = 14.96$ MHz.

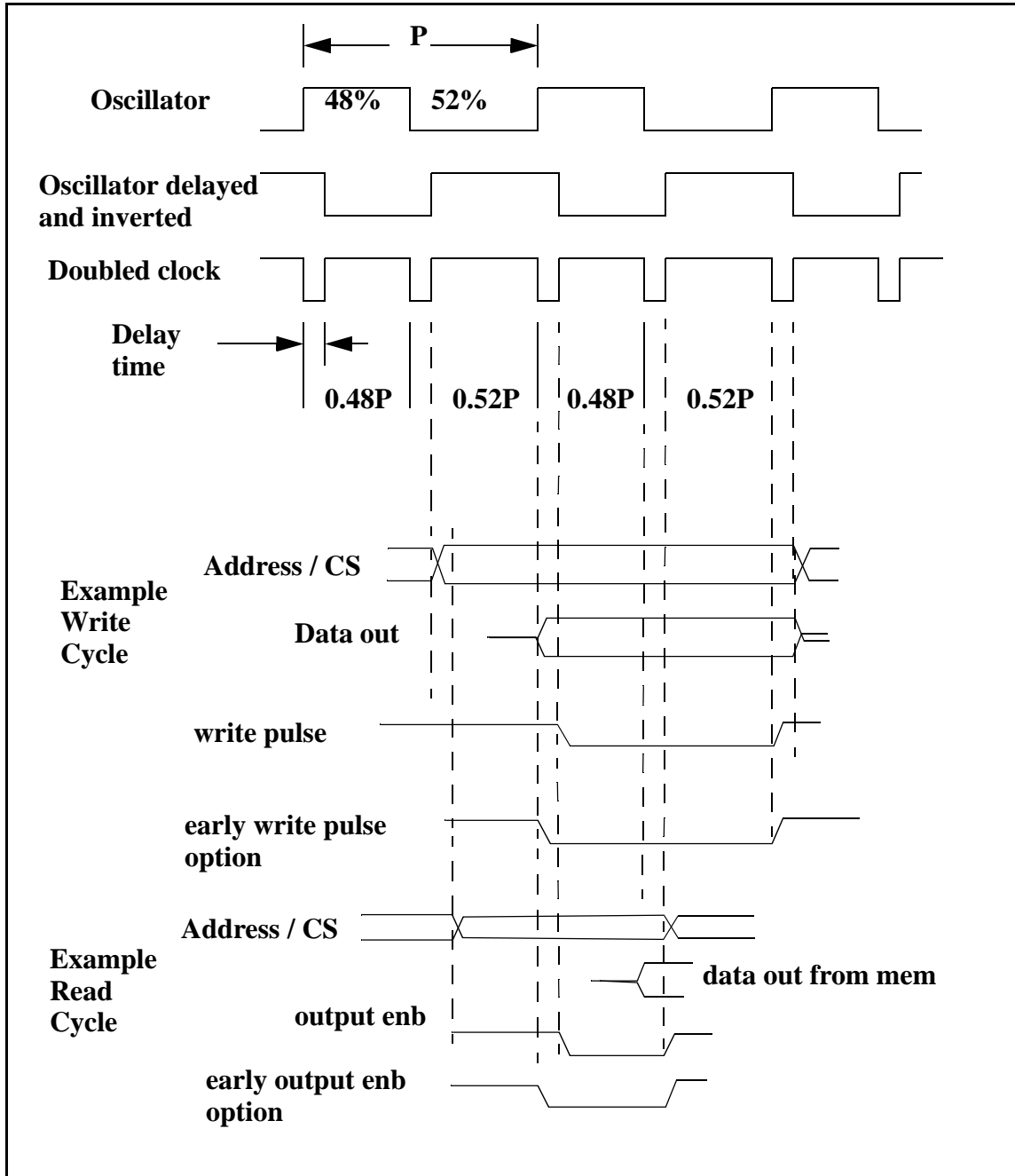


Figure 2. Memory Bus Cycle

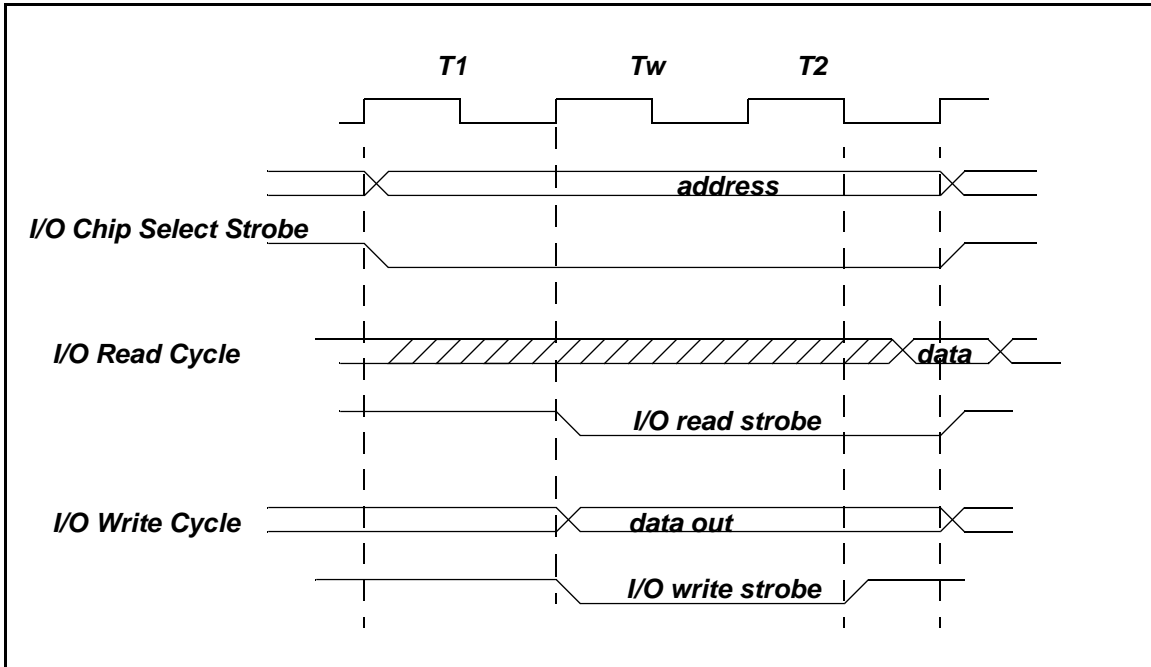


Figure 3. I/O Bus Cycles

LQFP Package

Pinout

Rabbit 3000 (AT56C55-ILIT)
 128-pin Low-Profile Quad Flat Pack (LQFP)
 14 × 14 Body, 0.4 mm pitch

VDDIO	1	VSSIO	128
CLK	2	PF7, AQD2A, PWM3	127
/CS2	3	PF6, AQD2B, PWM2	126
STATUS	4	PF5, AQD1A, PWM1	125
/OE0	5	PF4, AQD1B, PWM0	124
A10	6	PB7, IA5, /SLAVEATTN	123
/CS0	7	PB6, IA4	122
VDDCORE	8	PB5, IA3, SA1	121
VSSCORE	9	PB4, IA2, SA0	120
D7	10	PB3, IA1, /SRD	119
D6	11	PB2, IA0, /SWR	118
D5	12	PB1, CLKA	117
D4	13	PB0, CLKB	116
D3	14	VDDIO	115
D2	15	XTALA2	114
VSSIO	16	XTALA1	113
VDDIO	17	VSSIO	112
D1	18	PA7, ID7, SD7	111
D0	19	PA6, ID6, SD6	110
A0	20	PA5, ID5, SD5	109
A1	21	PA4, ID4, SD4	108
A2	22	PA3, ID3, SD3	107
A3	23	PA2, ID2, SD2	106
VDDCORE	24	PA1, ID1, SD1	105
VSSCORE	25	PA0, ID0, SD0	104
/SCS, I7, PE7	26	PF3, QD2A	103
16, PE6	27	PF2, QD2B	102
INT1B, I5, PE5	28	PF1, QD1A, CLKC	101
INT0B, I4, PE4	29	PF0, QD1B, CLKD	100
13, PE3	30	/WE1	99
12, PE2	31	A19	98
VSSIO	32	VDDIO	97
VDDIO,	33	VSSIO	96
INT1A, I1, PE1	34	/OE1	95
INT0A, I0, PE0	35	A11	94
RXE, PG7	36	A9	93
TXE, PG6	37	A8	92
RCLKE, PG5	38	A13	91
TCLKE, PG4	39	A14	90
/IOWR	40	VSSCORE	89
/IORD	41	VDDCORE	88
/BUFEN	42	VSSCORE	87
/WDIOUT	43	A17	86
SMODE1	44	A18	85
SMODE0	45	A16	84
/RESET	46	A15	83
/CS1	47	A12	82
VSSIO	48	VDDIO	81
CLK32K	49	VSSIO	80
RESOUT	50	A7	79
VBAT	51	A6	78
ARXA, PD7	52	A5	77
ATXA, PD6	53	A4	76
ARXB, PD5	54	PC0, TXD	75
ATXB, PD4	55	PC1, RXD	74
PD3	56	VSSCORE	73
PD2	57	VDDCORE	72
PD1	58	PC2, TXC	71
PD0	59	PC3, RXC	70
RXF, PG3	60	PAC4, TXB	69
TXF, PG2	61	PC5, RXB	68
RCLKF, PG1	62	PC6, TXA	67
TCLKF, PG0	63	PC7, RXA	66
VSSIO	64	VDDIO	65

Figure 4. Package Outline and Pin Assignments

Package Mechanical Dimensions and Land Pattern

Figure 5 shows the mechanical dimensions of the Rabbit LQFP package.

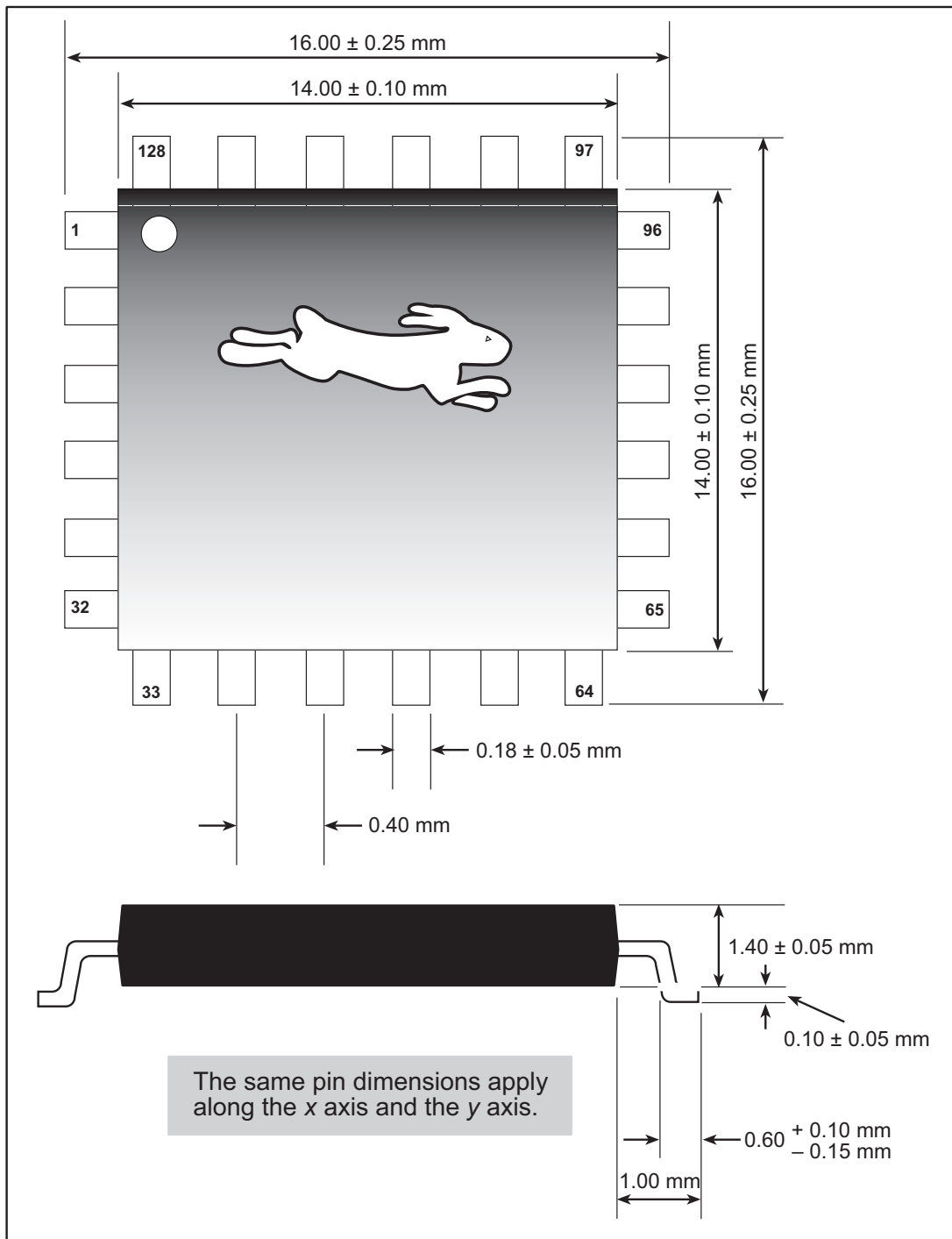


Figure 5. Mechanical Dimensions Rabbit LQFP Package

Figure 6 shows the PC board land pattern for the Rabbit 3000 chip in a 128-pin LQFP package. This land pattern is based on the IPC-SM-782 standard developed by the Surface Mount Land Patterns Committee and specified in *Surface Mount Design and Land Pattern Standard*, IPC, Northbrook, IL, 1999.

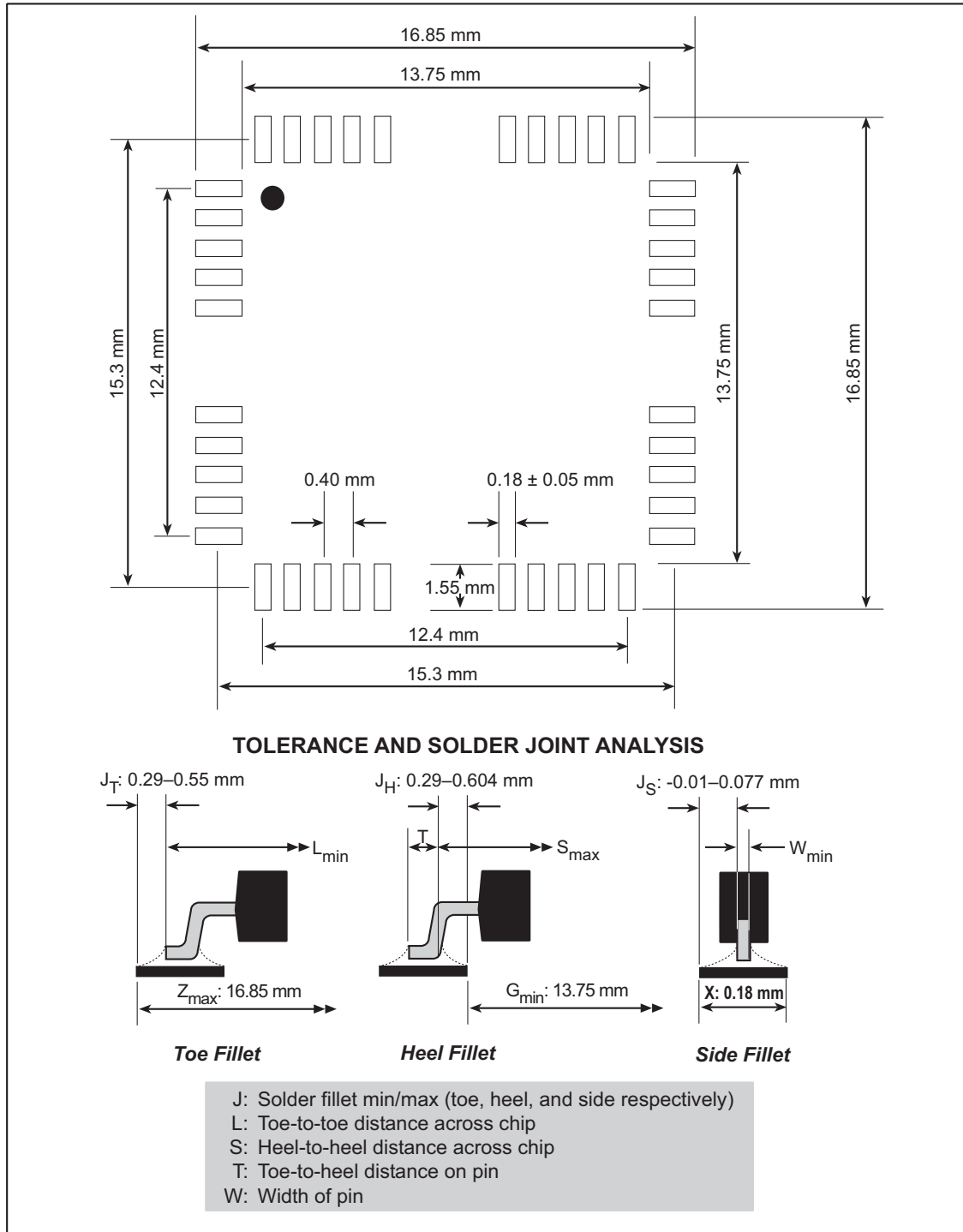


Figure 6. PC Board Land Pattern for Rabbit 3000 128-pin LQFP

Ball Grid Array Package

Pinout

Rabbit 3000 (AT56C55-IZ1T)

128-pin Thin Map Ball Grid Array (TFBGA)

10 × 10 Body, 0.8 mm pitch

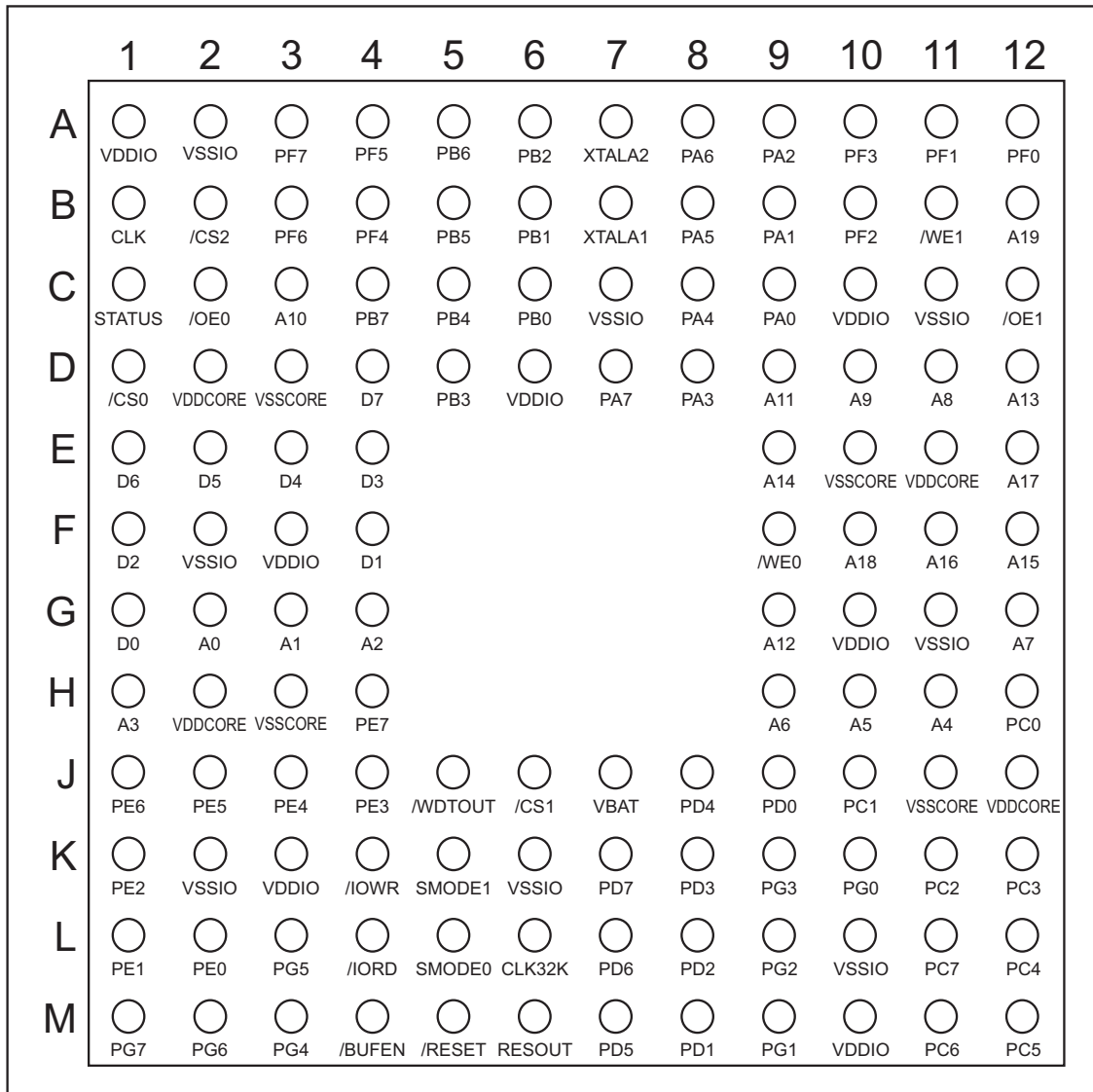


Figure 7. Ball Grid Array Pinout Looking Through the Top of Package

Mechanical Dimensions and Land Pattern

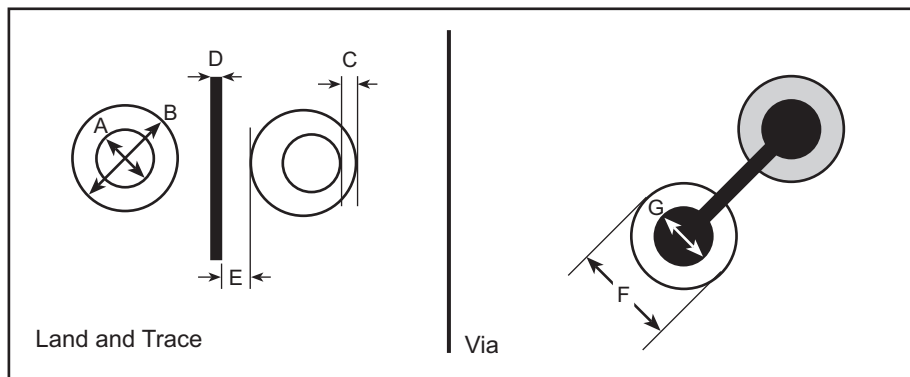
Table 2. Ball and Land Size Dimensions

Nominal Ball Diameter (mm)	Tolerance Variation (mm)	Ball Pitch (mm)	Nominal Land Diameter (mm)	Land Variation (mm)
0.3	0.35–0.25	0.8	0.25	0.25–0.20

The design considerations in Table 3 are based on 5 mil design rules and assume a single conductor between solder lands.

**Table 3. Design Considerations
(all dimensions in mm)**

Key	Feature	Recommendation
A	Solder Land Diameter	0.254 (0.010)
B	NSMD Defined Land Diameter	0.406 (0.016)
C	Land to Mask Clearance (min.)	0.050 (0.002)
D	Conductor Width (max.)	0.127 (0.005)
E	Conductor Spacing (typ.)	0.127 (0.005)
F	Via Capture Pad (max.)	0.457 (0.018)
G	Via Drill Size (max.)	0.254 (0.010)



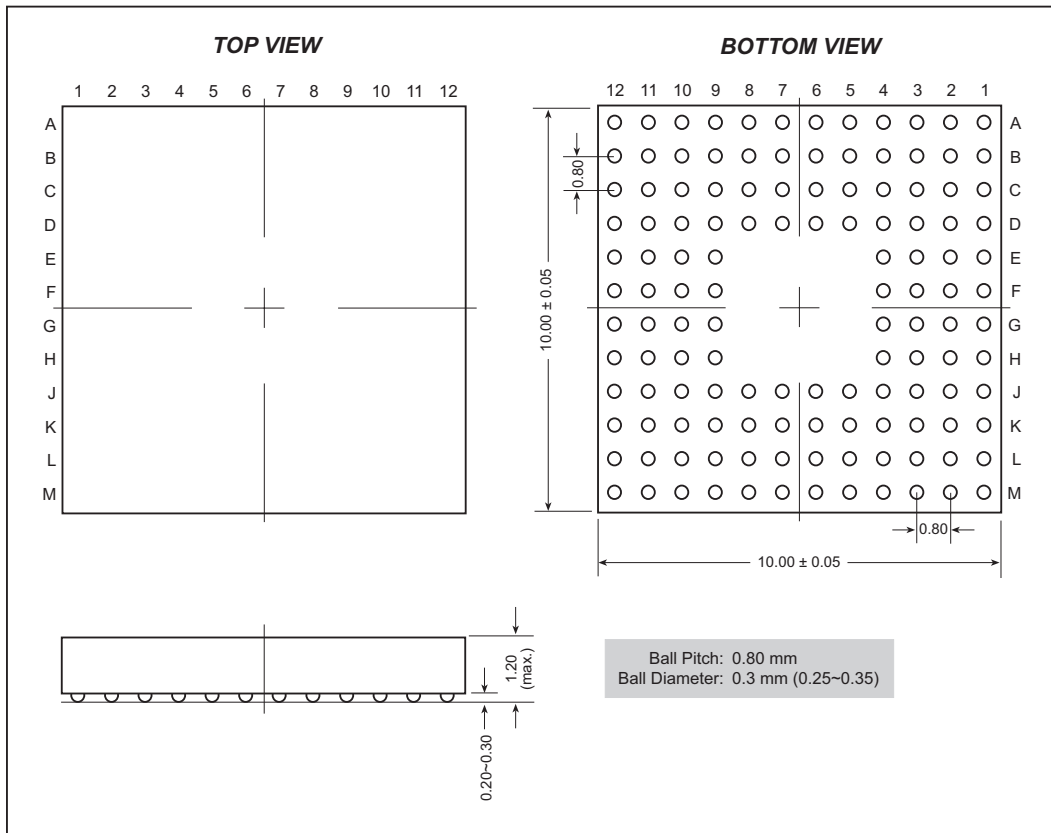


Figure 8. BGA Package Outline

Rabbit Pin Descriptions

Table 4 lists all the pins on the device, along with their direction, function, and pin number on the package.

Table 4. Rabbit Pin Descriptions

Pin Group	Pin Name	Direction	Function	Pin Numbers LQFP	Pin Numbers TFBGA
Hardware	CLK	Output	Internal Clock	2	B1
	CLK32K	Input	32 kHz Oscillator In	49	L6
	/RESET	Input	Master Reset	46	M5
	RESOUT	Output	Reset Output	50	M6
	XTALA1	Input	Main Oscillator In	113	B7
	XTALA2	Output	Main Oscillator Out	114	A7
CPU Buses	ADDR[19:0]	Output	Address Bus	various	
	DATA[7:0]	Bidirectional	Data Bus	10–15, 18–19	D4, E1–E4, F1, F4, G0
Status/Control	/WDTOUT	Output	WDT Time-Out	43	J5
	STATUS	Output	Instruction Fetch First Byte	4	C1
	SMODE[1:0]	Input	Bootstrap Mode Select	44, 45	K5, L5
Memory Chip Selects	/CS0	Output	Memory Chip Select 0	7	D1
	/CS1	Output	Memory Chip Select 1	47	J6
	/CS2	Output	Memory Chip Select 2	3	B2
Memory Output Enables	/OE0	Output	Memory Output Enable 0	5	C2
	/OE1	Output	Memory Output Enable 1	95	C12
Memory Write Enables	/WE0	Output	Memory Write Enable 0	86	F9
	/WE1	Output	Memory Write Enable 1	99	B11
I/O Control	/BUFEN	Output	I/O Buffer Enable	42	M4
	/IORD	Output	I/O Read Enable	41	L4
	/IOWR	Output	I/O Write Enable	40	K4
I/O ports	PA[7:0]	Input / Output	I/O Port A	111–104	D7, A8, B8, C8, D8, A9, B9, C9

Table 4. Rabbit Pin Descriptions (continued)

Pin Group	Pin Name	Direction	Function	Pin Numbers LQFP	Pin Numbers TFBGA
I/O ports (continued)	PB[7:0]	Input / Output	I/O Port B	123–116	C4, A5, B5, C5, D5, A6, B6, C6
	PC[7:0]	4 In / 4 Out	I/O Port C	66–71, 74, 75	L11, M11, M12, L12, K12, K11, J10, H12
	PD[7:0]	Input / Output	I/O Port D	52–59	K7, L7, M7, J8, K8, L8, M8, J9
	PE[7:0]	Input / Output	I/O Port E	26–31, 34, 35	H4, J1–J4, K1, L1–L2
	PF[7:0]	Input / Output	I/O Port F	127–124, 103–100	A3, B3, A4, B4, A10, B10, A11, A12
	PG[7:0]	Input / Output	I/O Port G	36–38, 60– 63	M1, M2, L3, M3, K9, L9, M9, K10
Power, processor core	VDDCORE		+3.3 V	8, 24, 72, 88	D2, E11, H2, J12
Power Processor I/O Ring	VDDIO		+3.3 V	1, 17, 33, 65, 81, 97, 115	A1, C10, D6, F3, G10, K3, M10
Power Battery Backup	VBAT		+3.3 V or battery	51	J7
Ground Processor Core	VSSCORE		Ground	9, 25, 73, 89	D3, E10, H3, J11
Ground Processor I/O Ring	VSSIO		Ground	16, 32, 48, 64, 80, 96, 112, 128	A2, C7, C11, F2, G11, K2, K6, L10

Rabbit 3000 Architecture and Software

Many software development systems marketed as tools for developing embedded software lack an appreciation for the subtleties and instead blindly follow a model that is suited for an environment where an all-powerful operating system supervises the application program. But in embedded software the application program and the operating system are one.

Our development platform, Dynamic C, is focused on the embedded world, and it has a multitude of features that have no analogy in the world of Unix or Windows. Our language-based multitasking is one example. Another language support is for the recovery of variables located in battery-backed RAM after a system upset. Watch expressions, which are C expressions entered at the console for debugging purposes, can include calls to functions and can be used to trigger hardware activity, something not found in other systems that execute watch expressions in the development platform host rather than in the embedded target.

Processor Architecture

The Rabbit's registers are nearly identical to those of the Z180 or the Z80. The figure below shows the register layout.

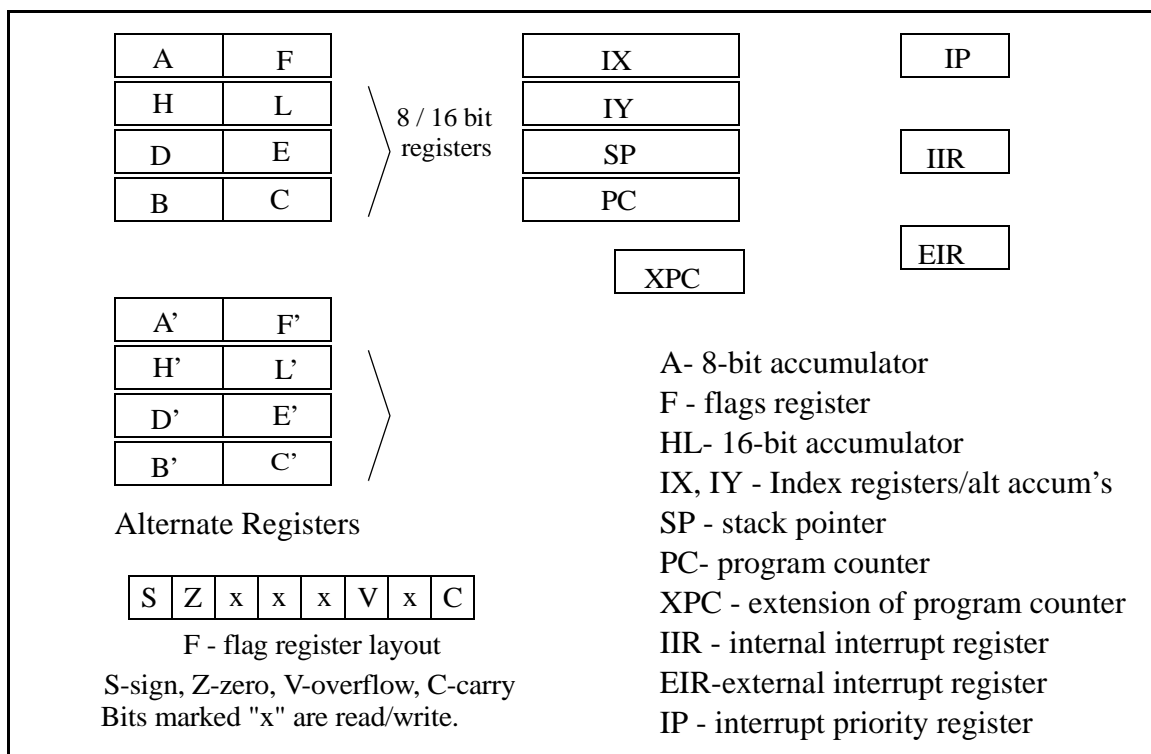


Figure 9. Rabbit Registers

Compared to the Z80, the XPC and IP registers are new. The XPC register is used to manage the extended megabyte of code memory. The EIR register is the same as the Z80 I register, and is used to point to a table of interrupt vectors for the externally generated interrupts. The IIR register occupies the same logical position in the instruction set as the Z80 R register, but its function is to point to an interrupt vector table for internally generated interrupts.

An important feature of the Rabbit is multiple priority interrupts. The IIR register is used to implement interrupt priority at 3 levels, 1, 2 or 3 (highest).

Instruction Set

The Rabbit instruction set is identical to the Z80 and Z180, except that a few instructions have been eliminated and some important new instructions have been added. The changes generally improve the instructions set, especially from the standpoint of improving the quality and execution speed of compiler generated C code. The changes are summarized below:

- Execution speed for a Rabbit 3000 is approximately 4x faster compared to a Z180 and 5x faster compared to a Z80 for C generated code.
- 16 bit loads and stores relative to the stack pointer and index registers greatly improve C code.
- New instructions make the alternate register set accessible and usable.
- I/O device access is now performed by prefixed memory instructions rather than dedicated I/O instructions. Most memory access instructions can access I/O space instead of they are prefixed.
- Long jumps and returns allow a full megabyte of code space.
- Long memory address stores and loads allow accessing a full megabyte of data.
- Instructions generally execute in 2 clocks per instruction byte except for an additional clock required for some instructions to compute a memory address. The 16 x 16 multiply requires 12 clocks.

Development Environment/Dynamic C

Dynamic C is an integrated development environment that is used to interactively develop code and perform debugging for Rabbit-based systems. Dynamic C itself runs on a PC under Windows. It communicates and controls a Rabbit-based system being used for software development in one of two ways, each way depending on the existence of a standard diagnostic/programming connector on the Rabbit-based target system. The standard programming connector is a 10-pin, 2 mm header that is connected to Serial Port A and certain lines used for initialization and handshaking. The programming connector, which adds only about \$0.25 to the cost of the target system, allows remote reset, startup, program load, and program debug. It can also be used as a low-cost serial interface for field setup of a system by loading operating parameters, etc.

The simplest method of connecting Dynamic C to a target system is to use a Rabbit programming cable. The programming cable uses a serial port on the PC to control the development process on the target. (Note that the programming cable previously supplied for 5 V Rabbit-2000-based systems is different from the programming cable used for Rabbit-3000-based systems.)

A more general solution is to use a RabbitLink card, which may be used to interface the target system to an ethernet connector and thence to a network or the Internet to which the PC hosting Dynamic C is also connected. Debugging then takes place communicating using TCP/IP to the RabbitLink card and then via the programming cable to the target being debugged. A direct Ethernet crossover cable from the PC to the RabbitLink card may also be used. In either case, Dynamic C has complete control of the target and retains the ability to reset the target and reload the software.

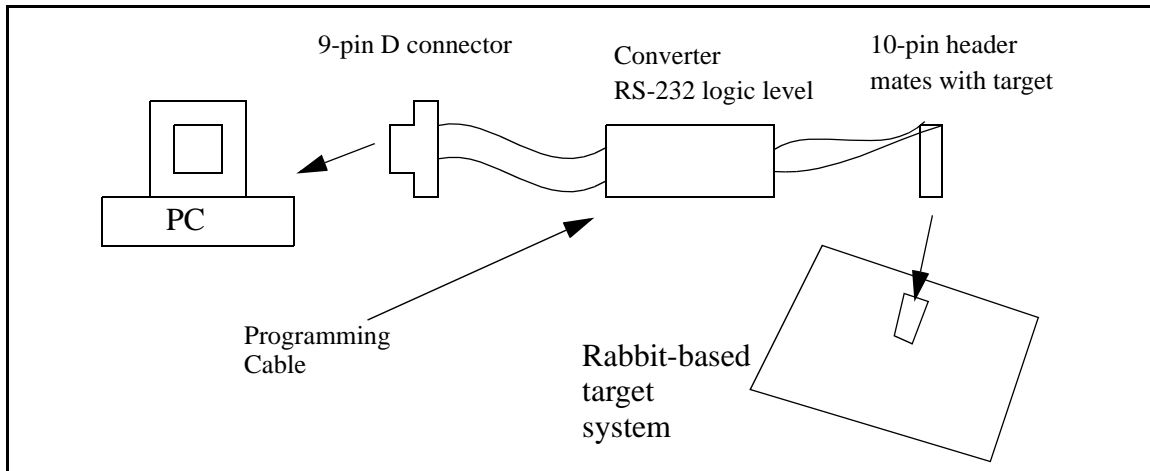


Figure 10. Use of Programming Cable

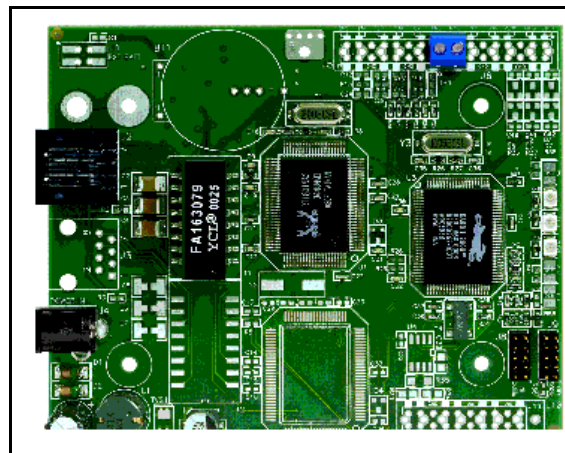


Figure 11. Z-World RabbitLink Board

Dynamic C presents a graphical user interface that includes an editor, assembler, C compiler, and debugger. Unlike some competitive development systems, Dynamic C is built from the ground up for the embedded environment. Issues such as startup initialization, support for battery backed memory, and memory-based file systems are approached with the embedded environment in mind.

A well known multitasking kernel, uCOS-2, is included with the full version of Dynamic C. However, Dynamic C also has built in language features that enable *cooperative* multitasking in a particularly simple and easy to understand way. Cooperative multitasking has substantial reliability and simplicity advantages over the traditional *preemptive* multitasking.

Key Features

- Fast compiler with one-step compiling and downloading to target
- Full-feature source and/or Assembly-level debugger
- Royalty-free TCP/IP stack with source code provided
- Hundreds of functions in source-code libraries and sample programs
- Exceptionally fast support for floating-point arithmetic and transcendental functions
- RS-232 and RS-485 serial communication
- Analog and digital I/O drivers
- I2C, SPI, GPS, Encryption, File System
- Powerful language extensions for cooperative or preemptive multitasking
- Loader utility program to load binary images into Z-World targets in the absence of Dynamic C
- Create your own source code libraries and augment on-line help by creating “function description” block comments using a special format for library functions
- Generate programs that use as much as 512K of data in SRAM and 512K of code in Flash or EPROM

Dynamic C’s enhancements over traditional UNIX style C compilers facilitate embedded programming. Language extensions include constructs for cooperative and preemptive multitasking and protecting writes to variables during power failures. Libraries for standard C functions, board-specific peripheral drivers, chip peripherals, and other features are included in source code format. Assembly-language programming is fully supported, and assembly code is easily mixed with C code for time-critical applications.

Developing software with Dynamic C is easy. Users can write, compile, and test C code, Assembly code, or even intermixed C and Assembly code without leaving the Dynamic C development environment. Debugging occurs while the application runs on the target. Alternatively, you can compile your program to an image file for later loading. Dynamic C runs on PCs under Windows 95, 98, 2000, NT, ME, and XP. Programs are downloaded at baud rates of 115,200 bps or higher while the program compiles.

Standard Debugging Features

- Breakpoints—Set breakpoints that can optionally disable interrupts.
- Single stepping—Step into or over functions at a source or machine code level.
- Code disassembly—The disassembly window displays addresses, opcodes, mnemonics, and machine cycle times.
- Switch between debugging at machine code level and source code level by simply opening or closing the disassembly window.
- Watch expressions—Watch expressions are compiled when defined, so complex expressions including function calls may be placed into watch expressions. Watch expressions can be

updated with or without stopping program execution and can be used to trigger the operation of hardware devices in the target.

- Register window—All processor registers and flags are displayed. The contents of general registers may be modified in the window by the user.
- Stack window—Shows the contents of the top of the stack.
- Hex memory dump—Displays the contents of memory at any address.
- **STDIO** window—`printf` outputs to this window, and keyboard input on the host PC can be detected for debugging purposes.

Network Connectivity and TCP/IP

The Rabbit can be connected to a network or the Internet and communicate in various ways with other devices, for example, a PC connected to the same network or another Rabbit-based system. The communication is performed using a series of protocols based on the Internet Protocol which sends packets in a certain format over the network.

The Rabbit supports 2 methods for implementing a connection to a network: Ethernet and modem-PPP. These are shown schematically below.

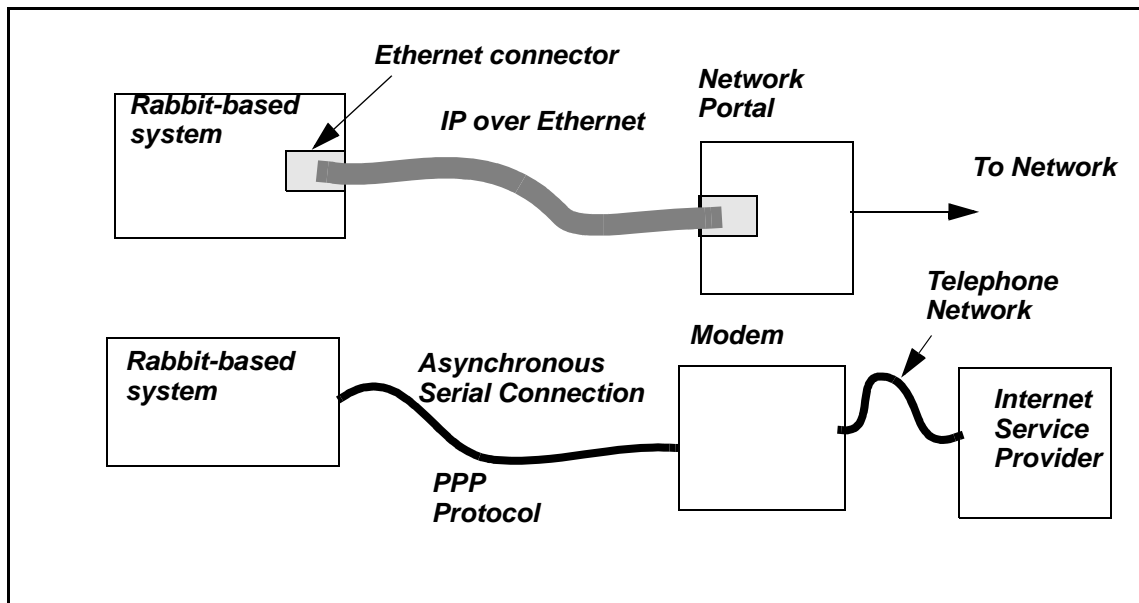


Figure 12. Rabbit-Based System Connection to Network or Internet

Although the portal to the network may be Ethernet, there may be a second connection using DSL, wireless, satellite link, etc. It is also possible to reduce the network to a single cable, connecting two devices together with an Ethernet crossover cable.

The Internet Protocol is based on 32-bit addresses and is normally written as 4 numbers in the range 0–255 and separated by periods, for example, 245.23.65.42. This provides 4 billion address, but there are techniques that allow many devices to share the same address by means of numbered ports. There are 65536 possible ports. By using private local IP address on a local network up to

65536 local IP addresses can be associated with each “real” Internet IP address of a gateway device to the local network. In this way a many embedded devices that are visible on the internet can be contacted by using both an IP address and a port number.

TCP/IP is a complex communications protocol that may be used to send a stream of characters between 2 devices in a network. It is based on bundling the characters in packets and sending them to a remote station specified by IP address and port number. Lost packets and other errors are corrected by re-sending the packets. The protocol is capable of high sustained transfer speeds even though the time for a given packet to reach its destination may be quite long on the Internet, in the hundreds of milliseconds or more. Due to the error correcting capabilities it is quite reliable and robust.

Dynamic C includes a TCP/IP “stack.” The stack is a library of C functions that may be included in the user’s program to implement network connections using TCP/IP. This opens many possibilities for Rabbit-based systems. For example two Rabbit-based systems or a Rabbit-based system and a PC can send each other messages over the Internet. The RabbitLink card described above is an example of a device that uses TCP/IP to communicate over a network. The messages between Dynamic C running on a PC and the target system being debugged are sent over a network using TCP/IP rather than over a programming cable connecting the PC to the Rabbit target system.

There are a number of higher level protocols that use the TCP/IP protocol for communication. The **HTTP** protocol is the protocol used for browsing Internet web sites. Dynamic C’s libraries support the HTTP protocol. This allows a Rabbit-based embedded system to operate as a Web site so that Web browser software (usually running on a PC) can be used to communicate with and control an embedded system based on the Rabbit. Demos are located at:

<http://demo.zweng.com>—explanation

<http://demo.zweng.com:8148/>—the weather server

This demonstration allows you to view the weather at Rabbit Semiconductor headquarters in Davis, California, U.S.A.

A browser can also send control information to a target system by means of functions supported under HTTP such as screen buttons or fill in fields.

The Rabbit libraries include protocols for sending and receiving e-mail. Thus an embedded system based on the Rabbit can receive instructions or send messages via e-mail. (**SMTP** and **POP3** protocols.)

The **FTP** protocol, supported for the Rabbit, is used for transmitting files is also supported. This allows the easy download of data from an embedded system to a PC or other system using a FTP file transfer program such as the Windows shareware program **CuteFTP**.

The **Telnet** protocol, supported by Dynamic C libraries, is used to connect a terminal to a device. This is a convenient way to communicate from a PC to a remote embedded device for control or setup of parameters.

There are many other protocols and features associated with the Rabbit network connectivity functionality which cannot be discussed in the space available here.

C Libraries

Dynamic C includes the standard C libraries the generally come with C compilers. These include libraries for character handling, for math and floating point, for formatting and printing and many other functions.

Dynamic C supports a flash or RAM **file system** which allows the creation of file systems held in permanent flash or battery backed SRAM memory. This is useful for systems that must log or accumulate data.

Dynamic C's **floating point** support is notable for its exceptional speed. Very few 8 or 16 bit processors can challenge the Rabbit in this area due to the exceptional floating point support. A floating point add or multiply executes in about 7 microseconds with a 50 MHz clock speed. The library functions such as sine or square root are also very quick. For example a floating square root is computed in about 20 microseconds.

Dynamic C libraries include a multitude of **drivers** to control the various peripheral devices of the Rabbit processor as well as to control various devices found on Z-World controller cards. One such device, for example, is the Realtek 8019 ethernet interface chip.

Dynamic C includes a **Fourier transform** signal processing library. A fourier transform, transforming 1024 real samples into 512 complex frequencies requires only 33 milliseconds with a 50 MHz clock. The calculation is done with 16 bit integers using a block floating exponent and dynamic scaling for excellent dynamic range.

Benchmarks

The benchmarks below were measured for various comparable processors. The Dhrystone is an integer and logic operation benchmark. The Whetstone is a floating point math and library benchmark. The Sieve is a short benchmark that measures integer, logic and looping operations. The top practical or top obtainable clock speed was used. In order to obtain these speeds it is necessary to use fast RAM on the Rabbit or ez80. As can be seen, the Rabbit is superior in every category.

Table 5. Microprocessor Benchmarks

Operation/ Program	Rabbit 3000 @50 MHz Dynamic C	AMD 188ES @40 MHz Borland 3.31 C	Zilog ez80 @40 MHz Zilog C compiler	Zilog Z180 @33 MHz Dynamic C	Dallas DS80C320 (8051) @33 MHz Keil C	Phillips 80C51 @ 33 MHz Keil C
Dhrystone 1.1 1000's/sec	6,570	3,603	2,914	1,719	1,251	598
Whetstone 1000's/sec	813	61	20	79	140	61
Sieve (milliseconds)	53	120	158	303	160	350

Low-EMI Solutions

The Rabbit 3000 has six powerful design features that greatly reduce problems encountered in passing government-sponsored EMI tests. These measures are so effective that it is almost impossible to have an EMI problem with the Rabbit 3000. For this reason we have applied the designation “The EMI-free microprocessor” to the Rabbit 3000. The six features that reduce EMI are:

- A *clock doubler* allows external the oscillator to operate at ½ the internal clock frequency.
- *Separate power pins* for the processor core and I/O ring prevents propagation of core noise to signal lines exiting the microprocessor package.
- *Gated clocks* in the internal logic - blocks the clock driving parts of the processor clock tree that are not in use for a particular instruction. This reduces the amplitude of EMI generated by clock related current surges.
- An *auxiliary I/O bus* limits loading and makes unnecessary the physical extension of fast data and address lines in system.
- *Bus architecture* allows designs that don't require routing clock out of processor.
- A *clock spectrum spreader* reduces EMI amplitude derived from the clock by up to 25 dB.

Electromagnetic interference (EMI) and electro-magnetic compatibility (EMC) represent a continuing problem for the embedded microprocessor system designer. Government regulations such as those surrounding the CE mark in Europe and FCC regulations in the U.S. require that certain digital systems be tested or certified not to radiate unintentional radiation (radio waves) above limits that depend on frequency and on the intended end use of the product. For example, devices that are used in an industrial environment, such as a factory, may not be subjected to any regulation. Limitations may apply to devices that will be used in a commercial environment such as an office. The most stringent regulations (e.g., FCC Class B) typically apply to devices intended for home use.

Technical Note 221, *PC Board Layout Suggestions for the Rabbit 3000 Microprocessor*, provides further information on mitigating radiated emissions, and provides detailed guidelines for PCB layout.

Using the Clock Spectrum Spreader

The spectrum spreader is very powerful for reducing EMI because it will reduce all sources of EMI above 100 MHz that are related to the clock by about 15–25 dB. This is a very large reduction since it is common to struggle to reduce EMI by 5 dB in order to pass government tests.

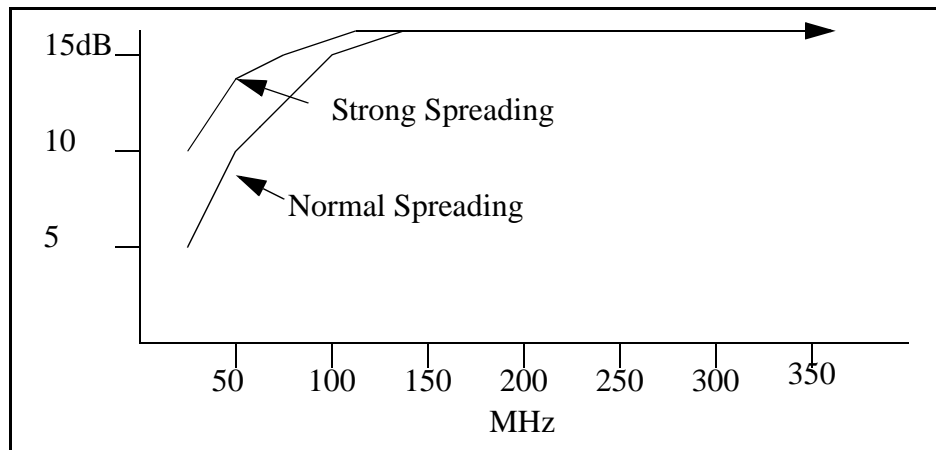


Figure 13. Peak Spectral Amplitude Reduction from Spectrum Spreader

The spectrum spreader modulates the clock so as to spread out the spectrum of the clock and its harmonics. Since the government tests use a 120 kHz measurement bandwidth to measure EMI, spreading the energy of a given harmonic over a wider bandwidth will decrease the amount of EMI measured for a given harmonic. The spectrum spreader not only reduces the EMI measured in government tests, but it will also reduce the interference created for radio and television reception.

The spectrum spreader has three settings under software control: off, normal spreading, and strong spreading. When the spectrum spreader is engaged, the frequency is modulated and individual clock cycles may be shortened or lengthened by an amount that depends on whether the clock doubler is engaged and whether the spectrum spreader is set to the normal or strong setting. The frequency modulation amplitude and the change in clock cycle length is greater at lower voltages or higher temperatures since it is sensitive to process parameters and is proportional to the switching speed. The spectrum spreader also introduces a time offset in the system clock edge and an equal offset in edges generated relative to the system clock. A feedback system limits the worst case time error of any signal edge derived from the system clock to plus or minus 20 nanoseconds for the normal setting, and plus or minus 40 nanoseconds for the strong setting at 3.3 V. The maximum time offset is inversely proportional to the operating voltage. The time error will not usually interfere with communications channels, except perhaps at the extreme higher data rates. More details on dealing with the clock variation introduced are available in the *Rabbit 3000 Microprocessor User's Manual*.

Low-Power Solutions

The Rabbit 3000 has an extensive bundle of features aimed at low-power and extreme low power operation. Competitive processors often have virtually no low-power features or only crude features such as a sleep mode with an input to cause the processor to wake up in response to an external command. An associated feature is battery backup of memory and the time/date clock.

Sources of Power Consumption

The Rabbit 3000 is a static design and it consumes no current when the clock frequency is zero except for a small leakage current on the order of a few microamperes. When the clock is operating, current is needed to charge and discharge internal capacitances and to provide power for crossover current when CMOS gates transition and both the N and P transistors are momentarily conducting. The current consumed is proportional to both the operating frequency and the operating voltage. Cutting the operating voltage in half, from 3.3 V to 1.65 V, will reduce power by a factor of 4 since both voltage and current are cut by a factor of 2.

The main oscillator that is built into the Rabbit 3000 is a special case because it operates in a linear mode of operation with an output signal resembling a sine wave more than a square wave. Most of the current consumed is due to crossover current during the slow transition of the output signal. The duty cycle of the crossover current is independent of frequency and as a result the current consumed by the oscillator is independent of frequency and is about 1 mA at 3.3 V. The current consumed by the oscillator is proportional to the square of the voltage above the gate threshold because as the voltage is lowered the crossover resistance increases due to less gate drive. The result is that oscillator power drastically decreases with voltage. If VDD is 1.65 V, the oscillator current drops from 1 mA to about 0.1 mA, and power drops by a factor of 20.

Memories can be responsible for a substantial amount of power consumption because the current consumed may not be strictly proportional to operating frequency. This is particularly true of flash memory, which may have internal charge pumps and other circuits that consume current independently of operating frequency. The low-frequency power consumption of memory chips is not usually well documented, forcing the engineer to resort to experiment to develop his own spec. However, many memories have a standby current specified when the chip select line is held high. The Rabbit 3000 takes advantage of this by having low chip select duty cycle modes that are available with low clock speeds. This greatly reduces the contribution of the memory chips to power consumption when operating at low clock speeds.

Options for Lowering the Clock Speed

If the clock doubler is in use, and we suggest that it be normally used, then it can be turned off and the system frequency will be cut in half. In addition the clock can be further divided under program control by a factor of 2, 4, 6, or 8. To further slow down the clock the processor clock source can be switched to the 32 kHz oscillator. This clock source can be further divided by 2, 4, 8, or 16, bringing the processor clock to as low as 2 kHz. When the 32 kHz oscillator is used as a clock source, the main oscillator can be optional disabled, removing it as a source of power consumption. When the maximum power saving features are enabled current consumption can go below 20 μ A and the processor is still executing instructions, albeit at a few kHz.

Clock Frequency (MHz)	Voltage (V)	Current (mA)
51.6	3.3	104
29.49	3.3	60
14.7456	3.3	31
7.3728	3.3	16
3.6864	3.3	8.5
1.8432	3.3	4.7
1.8432	1.8	1.7
0.9216	3.3	2.75
0.9216	2.8	2.2
0.9216	1.8	1.05
0.4608	3.3	1.7
0.032 (sleepy mode)	3.3	0.113
0.08 (sleepy mode)	3.3	0.029
0.08	1.8	0.015
0.02	1.8	0.004 (Negl. Leak)

Operating at 1.8 V with a 0.92 MHz clock, 2 AA alkaline batteries that have a capacity of about 1700 mA hours, and a linear regulator would result in continuous operation for approximately 2000 hours or a full year of working days (considering only the processor current draw). At this clock speed the Rabbit 3000 is still faster than the original 2 MHz Z80, and executes about 400,000 instructions per second. Such a system, if it uses a 3.68 MHz oscillator, is still capable of bursts of speed up to 7.37 MHz by turning the clock divider off and turning on the clock doubler.

Sleepy Mode

When the processor is operating at 32 kHz or less, we call this the sleepy mode. Current consumption is very low, often less than 50 μ A, but the processor can still execute instructions, keep track of the time, and control and read I/O lines. A simple use of the sleepy mode is to wait for a certain amount of time and then wake up by speeding up the clock. It is also possible to poll an external line waiting for an event and then speeding up the clock to handle the event. It is obvious that the sleepy mode is intelligent and is much more powerful than the “sleep” mode found in other processors.

Memory Chip Selection Options

When static memories operate at high speed, the dominant source of current consumption is usually the charging and discharging of internal and external capacitances. This results in a current consumption proportional to frequency. However, if the operating speed is very low, other mechanisms that consume current independent of frequency may begin to predominate. These mechanisms may consume only leakage current or current of many milliamperes. The low-operating-frequency current for flash or very fast SRAM tends to be in the milliampere region, but low-power SRAM may only consume small leakage currents. Whatever the case, most static memories have a standby mode, entered by raising the chip select line, that consumes the minimum possible current, often often 1–10 μA . The static current consumed when the chip select is low and the other inputs are quiet is not usually specified by the memory manufacturers or a specification that is much higher than reality is given. If the Rabbit clock is simply slowed down, the memory cycle simply becomes longer and the chip select, especially on the memory used for code storage, usually a flash, remains low most of the time. To lower the long duty cycle of chip select enabled, the Rabbit 3000 has 2 special modes for operating the chip select. If the processor clock is divided by 4, 6 or 8 a *short chip select mode* can be enabled. In this mode the chip select is not enabled until the last 2 undivided clocks of the memory bus cycle. If the clock is divided by 8 then the chip select will be on for only the last $\frac{1}{4}$ of the cycle and the chip select on duty cycle is reduced by a factor of 4.

When the processor clock has been switched to the 32 kHz oscillator, an additional mode of controlling the chip select on is available. In this case a memory cycle that is self timed by an on-chip delay loop is enabled. The chip select on time can be limited to a few hundred nanoseconds out of the 64 μs or longer bus cycle resulting in a chip select on duty cycle of 1% and considerably less if the 32 kHz clock is divided down.

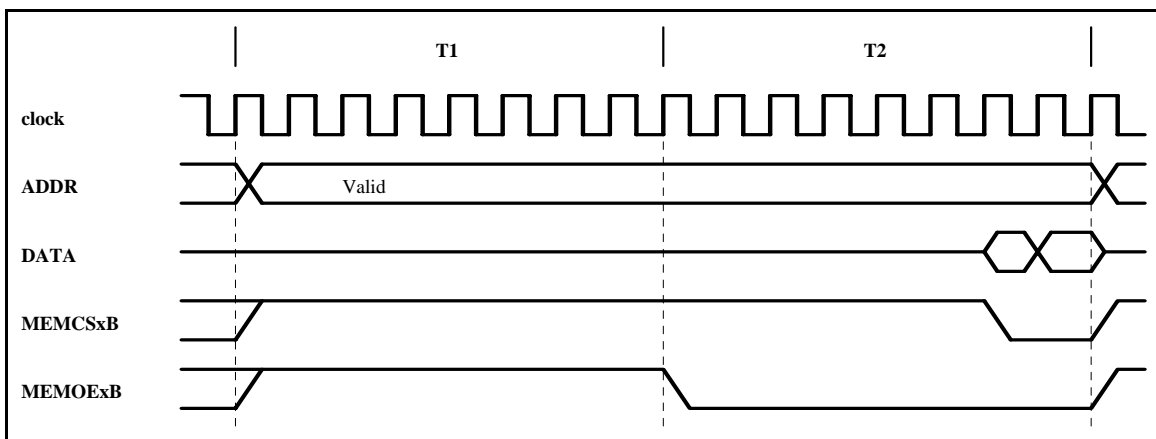


Figure 14. Short Chip Select Memory Read

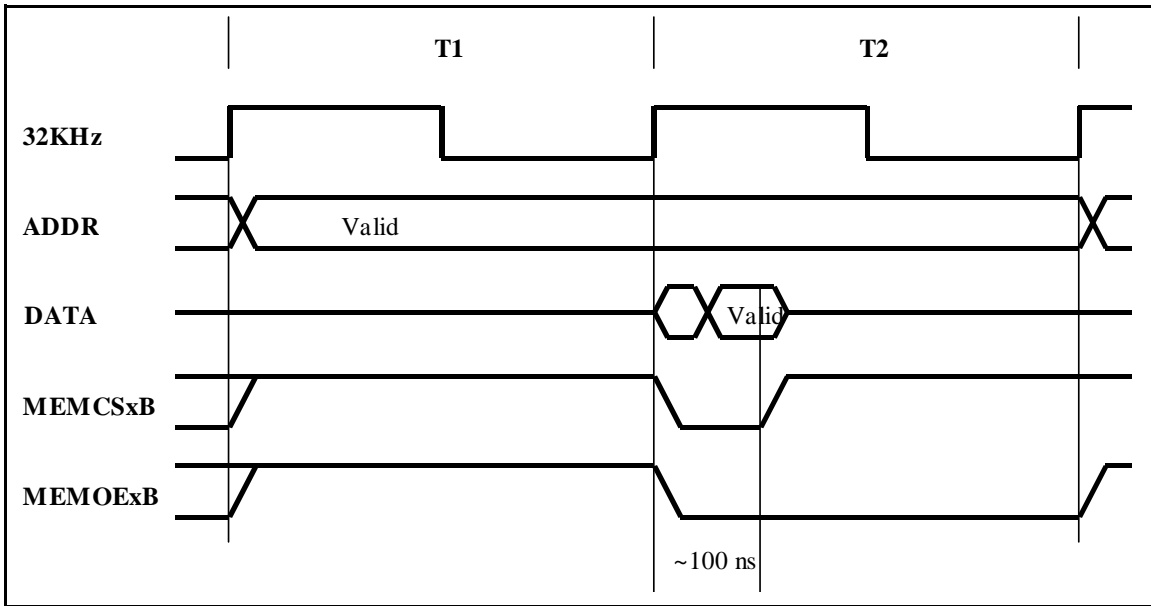


Figure 15. Self-Timed Chip Select Memory Read Cycle

Battery-Backed Time/Date and Battery-Backed Memory

The Rabbit has an internal time/date clock, often called a real-time clock. In the Rabbit this device is a 48-bit counter that counts at 32.768 kHz. At this counting rate, it requires about 126 years for the counter to roll over, and since zero time is by convention the start of 1980, the clock is good for the rest of this century.

The clock requires a very small current, on the order of a few microamperes. A separate power pin keeps can be used to keep the clock operating when the main system power is off. The Rabbit has several other circuits that are kept alive by this separate power pin. The /CS1 output is kept alive and placed in a high-impedance state when power is down and battery power is supplied via the VBAT pin. The RESOUT pin goes high during reset or during power down when it is held high by the battery supply. This signal is handy to drive the gate of a transistor that enables the battery-backup supply. The required circuit is shown below. In order to provide a battery-backed clock and SRAM, no special switching chip is required, only a single transistor, a few small parts and the battery.

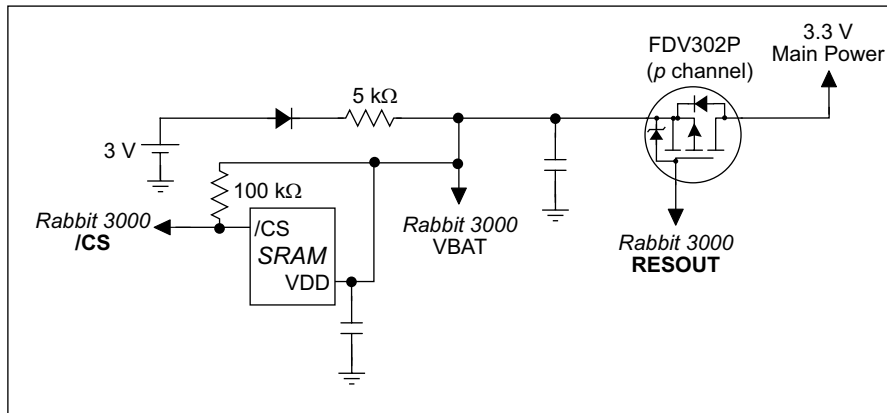


Figure 16. Battery-Backup Circuit

The Rabbit 3000 has been designed to accept a 32 kHz clock input from an external oscillator. A suggested oscillator circuit based on a tiny logic buffer is shown below. More details concerning this circuit are given in the *Rabbit 3000 Microprocessor User's Manual*. The external circuit has a very low parts cost and consumes less power than a built in buffer.

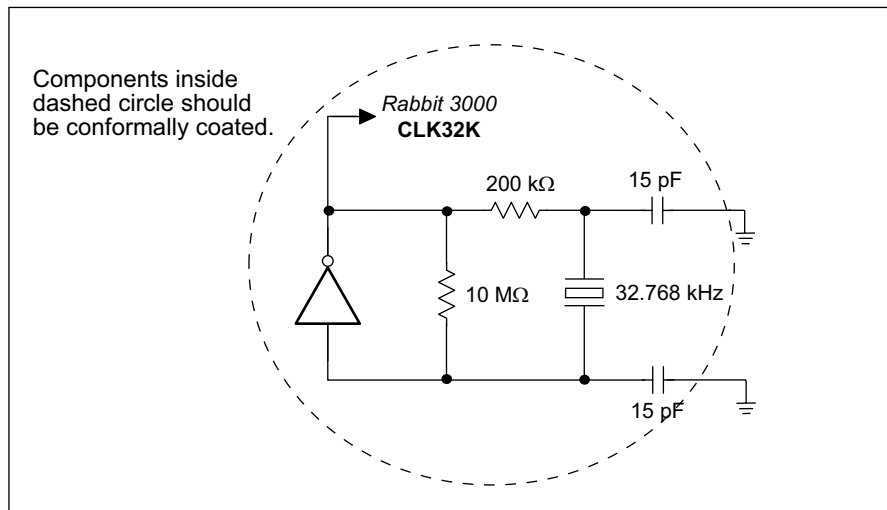


Figure 17. Sample Oscillator Circuit

It is feasible to operate the battery-backed SRAM and clock with 5 μ A of current, allowing a very long life, in excess of 10 years with a lithium button cell.

Sources of Support

Rabbit Semiconductor has long featured low-cost complete development kits that typically include a circuit board, power supply, programming cable, and software CD with a version of the Dynamic C development system and a suite of instruction manuals. These kits are not loss leaders designed to support a temporary burst of publicity and then to be forgotten. Each kit is well-designed, sold in high volume at a good profit, and is intended to remain on the market for a substantial period of time. Our development kits enable you to get a quick demonstration of our products or to begin a months-long development project.

Rabbit Semiconductor's close relationship with Z-World, Inc. means that there is a ready source of complete Rabbit-based controller boards and associated software.

The Z-World/Rabbit Semiconductor support center includes a bulletin board and frequently asked questions. In addition questions can be submitted to the support staff via e-mail:

www.zworld.com/support/support_submit.html

The Rabbit-semi group on Yahoo provides a forum for the exchange of information concerning the Rabbit microprocessor. There are about 1000 members and 700 messages per month.

<http://groups.yahoo.com/group/rabbit-semi/>

The Rabbit Semiconductor and Z-World Web sites contain many application notes, instruction manuals, and schematics that are applicable to Rabbit-based designs.

<http://www.rabbitsemiconductor.com>

<http://www.zworld.com>

Direct Support

Rabbit Semiconductor has a large staff of technical support engineers and they are backed up by the staff of hardware design and software engineers. Support by e-mail is generally available to all Rabbit customers. Telephone support, support from design engineers, or even an on-site visit by a field engineer are available depending on the circumstances and arrangements that are made. In some cases there may be a nominal charge.

Seminars/Trade Shows

From time to time Rabbit Semiconductor runs hands-on seminars in various locations around the world. These are announced on the Web site. We are also represented at trade shows, either directly or through a representative or distributor. These are also announced on the Web site.

Visits

Customers who are interested in seeing if we are "real" or who otherwise need to evaluate our capability as a supplier often visit our Davis, California, headquarters. Contact the sales department to arrange such a visit.

Documentation/Designs

Z-World and Rabbit Semiconductor publish schematics of the various products. In general there is no problem in using these designs as models for your own design. [If you wish to go into the business of selling controllers based on the Rabbit and programmable using Dynamic C to the general public, then we ask that you obtain a license from us. We are usually amenable to arranging such a license depending on the circumstances.]

Parts Store

Rabbit Semiconductor operates a parts store on its Web site. The purpose of the parts store is to ensure easy access to parts that are important for building Rabbit-based systems. Although the parts store is intended for users who need small quantities (hundreds or less) of parts, we can sometimes provide competitive prices for larger quantities. We expect that high-volume users will make their own arrangements with major manufacturers or distributors to obtain parts.

Development Kits

Our development kits are well known for being comprehensive and easy to use. Unlike our competitors our kits include full power development tools that don't have time or memory restrictions incorporated that are there to encourage you to purchase a more expensive (often \$5000 or more) development tool package.

Core Modules

We are not afraid to claim the title world leader in core modules. A core module is a small plug in board containing a Rabbit processor with memory, clock and associated circuitry. Some of our core modules also have an Ethernet interface with our without RJ-45 cable connector. A core module is a solution that is appropriate for low volume to fairly high volume designs where the emphasis is on quick time to market and low design cost. A variety of core modules are available from Rabbit Semiconductor.